L Number	Hits	Search Text	DB	Time stamp
1	357	laser with "1024"	USPAT;	2003/12/01 15:26
			US-PGPUB;	
			ЕРО; ЛРО;	
			DERWENT:	1
			IBM_TDB	
2	3888	laser with ("532" "355")	USPAT;	2003/12/01 15:24
_		1.1.00	US-PGPUB;	2003/12/01 13.24
				1
			EPO; JPO;	
			DERWENT;	1
,	1.5	(1	IBM_TDB	
3	15	(laser with "1024") and (laser with ("532" "355"))	USPAT;	2003/12/01 15:26
			US-PGPUB;	
			EPO; JPO;	
			DERWENT;	
ĺ			IBM TDB	
4	2570	laser with "1064"	USPAT;	2003/12/01 15:26
			US-PGPUB;	2000/12/01 15/20
			EPO; JPO;	
			DERWENT;	
5	1050	(logar with #1064#) and (long with (#522# #255#))	IBM_TDB	
٠	1059	(laser with "1064") and (laser with ("532" "355"))	USPAT;	2003/12/01 15:26
i			US-PGPUB;	
			ЕРО; ЛРО;	
			DERWENT;	ļ
			IBM_TDB	
6	897	(laser with "1064") same (laser with ("532" "355"))	USPAT;	2003/12/01 15:26
ŀ		, , , , , , , , , , , , , , , , , , , ,	US-PGPUB;	
			EPO; JPO;	
			DERWENT;	
i			IBM_TDB	
7	1	((laser with "1064") same (laser with ("532" "355"))) same (coarse		2002//2/01 15 20
.	•	dense lonely microload\$4 busy)	USPAT;	2003/12/01 15:28
		delise lonely microloads4 busy)	US-PGPUB;	
1			EPO; JPO;	
			DERWENT;	
_			IBM_TDB	
3	125	((laser with "1064") same (laser with ("532" "355"))) same (density)	USPAT;	2003/12/01 15:28
			US-PGPUB:	
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
9	14017	metal\$4 adj line	USPAT:	2003/12/01 15:28
1			US-PGPUB;	2003/12/01 13.28
1				
			EPO; JPO;	
			DERWENT;	
	226	(1304 1111) to (IBM_TDB	
10	336	(metal\$4 adj line) with (coarse or fine or lonely or dense)	USPAT;	2003/12/01 15:29
			US-PGPUB;	
	1		EPO; JPO;	
- 1			DERWENT:	
ſ	ļ		IBM TDB	
.1	0	((metal\$4 adj line) with (coarse or fine or lonely or dense)) and ((laser	USPAT:	2003/12/01 15:29
	1	with "1064") same (laser with ("532" "355")))	US-PGPUB;	2003/12/01 13.29
	J	, (and (20m 200)))		
	İ		EPO; JPO;	
			DERWENT;	
12		// - 104 P.P 14	IBM_TDB	
	0	((metal\$4 adj line) with (coarse or fine or lonely or dense)) and (laser	USPAT;	2003/12/01 15:29
1		with "1064")	US-PGPUB;	
	ļ		EPO; JPO;	
			DERWENT;	
			,	

14 216/3 cels. 218/3 cel					
14 5	13	14	((constant) and interpretation of the of total of the o	USPAT;	2003/12/01 15:44
15 377			216/\$.ccls.	US-PGPUB;	
15 377				EPO; JPO;	
15 ((metal\$4 adj line) with (coarse or fine or lonely or dense)) and USFĀT, USFQFUB; EPO, IPO, DERWENT; EPO, IPO, IPO, DERWENT; EPO, IPO, IPO, IPO, IPO, IPO, IPO, IPO, I	1			DERWENT:	
15 ((metal\$4 adj line) with (coarse or fine or lonely or dense)) and USFĀT, USFQFUB; EPO, IPO, DERWENT; EPO, IPO, IPO, DERWENT; EPO, IPO, IPO, IPO, IPO, IPO, IPO, IPO, I	1	i		IBM TDB	
219/8.ccls. US-PGPUB; Control or ablat\$4 or mill\$4) with (metal or metallic or tin or sn or metallization) with (mask\$4 or resist\$4) US-PGPUB; EPC, IPC, DERWENT; US-PGPUB; EPC, IPC, IPC, DERWENT; US-PGPUB; EPC, IPC, IPC, IPC, IPC, IPC, IPC, IPC, I	14	5	((metal\$4 adj line) with (coarse or fine or lonely or dense)) and		2003/12/01 15:32
laser with (crode or crosion or ablat\$4 or mill\$4) with (metal or metallic or tin or sn or metallization) with (mask\$4 or resist\$4) 16 16 10 10 11 10 11 11 11 12 12 13 13 13 13 14 15 15 16 16 10 16 16			219/\$.ccls.		
DERWENT;					
15 377 laser with (erode or erosion or ablat\$4 or mill\$4) with (metal or metallic or tin or sn or metallization) with (mask\$4 or resist\$4) US-PGPUB; EPO, IPO, DERWENT; IBM, TDB (laser with "1064") 2003/12/01 15:54 2003/12/01 15:54 2003/12/01 15:54 2003/12/01 15:54 2003/12/01 15:54 2003/12/01 15:54 2003/12/01 15:55 2003/12/01 15:54 2003/12/01 15:55 2003/12/01 15:54 2003/12/01 15:55 2003/12/01 15:54 2003/12/01 15:55 2003/12/01 15:5					
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16 0 (laser with (erode or erosion or ablat\$4 or mill\$4) with (metal or metallic or tin or sn or metallization) with (mask\$4 or resist\$4)) with (laser with "1064") 17 2 (laser with (erode or erosion or ablat\$4 or mill\$4) with (metal or metallic or tin or sn or metallization) with (mask\$4 or resist\$4)) with (laser with (erode or erosion or ablat\$4 or mill\$4) with (metal or metallic or tin or sn or metallization) with (mask\$4 or resist\$4)) with (laser with (erode or erosion or ablat\$4 or mill\$4) with (metal or metallic or tin or sn or metallization) with (mask\$4 or resist\$4)) 18 377 (laser with (erode or erosion or ablat\$4 or mill\$4) with (metal or metallic or tin or sn or metallization) with (mask\$4 or resist\$4)) 19 106 (laser with (erode or erosion or ablat\$4 or mill\$4) with (metal or metallic or tin or sn or metallization) with (mask\$4 or resist\$4)) and (pcb or pwb or board) 20 2334 (coarse or dense or lonely or isolated) same (pcb or pwb or board) same (mask\$4 or resist\$4 or pattern\$4) 21 21 21 ((coarse or dense or lonely or isolated) same (pcb or pwb or board) same (mask\$4 or resist\$4 or pattern\$4)) and ((laser with "1024") (laser with "1024") (laser with "105POP.DERWENT; BM TDB USPAT; US-POPUB; EPO, IPO, DERWENT; BM TDB USPAT; US-POPUB; EPO, I	1	i	or tin or sn or metallization) with (mask\$4 or resist\$4)		2003/12/01 13:51
16 0 (laser with (erode or erosion or ablat\$4 or mill\$4) with (metal or metallic or tin or sn or metallization) with (mask\$4 or resist\$4)) with (laser with "1064") 2003/12/01 15:54 17 2 (laser with (erode or erosion or ablat\$4 or mill\$4) with (metal or metallic or tin or sn or metallization) with (mask\$4 or resist\$4)) with (laser with ("532" "355")) 2003/12/01 15:55 18 377 (laser with (erode or erosion or ablat\$4 or mill\$4) with (metal or metallic or tin or sn or metallization) with (mask\$4 or resist\$4)) USPAT; US-PGPUB; EPO, IPO, DERWENT; BM TDB USPAT; US-PGPUB; EPO, IPO, IPO, IPO, IPO, IPO, IPO, IPO, I			(
16 0 0 (laser with (erode or erosion or ablat\$4 or mill\$4) with (metal or metallic or tin or sn or metallization) with (mask\$4 or resist\$4)) with (laser with "1064") 2 (laser with (erode or erosion or ablat\$4 or mill\$4) with (metal or metallic or tin or sn or metallization) with (mask\$4 or resist\$4)) with (laser with (erode or erosion or ablat\$4 or mill\$4) with (metal or metallic or tin or sn or metallization) with (mask\$4 or resist\$4)) with (laser with (erode or erosion or ablat\$4 or mill\$4) with (metal or metallic or tin or sn or metallization) with (mask\$4 or resist\$4)) USPAT; USPGPUB; EPO, IPO, DERWENT; IBM TDB USPAT; USPGPUB; IPO, IPO, IPO, IPO, IPO, IPO, IPO, IPO,					
16 0 (laser with (erode or erosion or ablat\$4 or mill\$4) with (metal or metallic or tin or sn or metallization) with (mask\$4 or resist\$4)) with (laser with "1064") 2003/12/01 15:54 2003/12/01 15:54 2003/12/01 15:54 2003/12/01 15:54 2003/12/01 15:54 2003/12/01 15:54 2003/12/01 15:54 2003/12/01 15:55 2003/12/01 15:54 2003/12/01 15:55 2003/12/01 15:54 2003/12/01 15:55 2003/12/01 15:54 2003/12/01 15:55 2003/12/01 1					
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18 377 (laser with ("532" "355")) EPO; IPO; DERWENT; BM TDB USPAT; US-PGPUB; EPO; IPO; DERWENT, BM TDB USPAT; US-PGPUB; EPO; IPO; IPO; IPO; IPO; IPO; IPO; IPO; I] ''		metallic or tip or an or metallization) with (mode@4		2003/12/01 15:55
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19 106 (laser with (erode or crosion or ablat\$4 or mill\$4) with (metal or metallic or tin or sn or metallization) with (mask\$4 or resist\$4)) and (pcb or pwb or board) 20 2334 (coarse or dense or lonely or isolated) same (pcb or pwb or board) same (mask\$4 or resist\$4 or pattern\$4) 21 ((coarse or dense or lonely or isolated) same (pcb or pwb or board) same (mask\$4 or resist\$4 or pattern\$4)) and ((laser with "1024") (laser		1	metallic or tin or sn or metallization) with (mask\$4 or resist\$4))		
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21	20	2224			
21 ((coarse or dense or lonely or isolated) same (pcb or pwb or board) same (mask\$4 or resist\$4 or pattern\$4)) and ((laser with "1024") (laser with "USPAT; USPGPUB; EPO; IPO; DERWENT; BM_TDB USPAT; USPGPUB; EPO; IPO; DERWENT; EPO; IPO;	20	2334	(coarse or dense or lonely or isolated) same (pcb or pwb or board) same		2003/12/01 16:40
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22 12337 (coarse or dense or lonely or isolated) near2 (mask\$4 or resist\$4 or pattern\$4) 2003/12/01 16:41 US-PGPUB; EPO; IPO; DERWENT; BM, TDB USPAT; US-PGPUB; EPO; IPO; DERWENT; DES-PGPUB; EPO; IPO; IPO; DES-PGPUB; EPO; IPO; I			(mask\$4 or resist\$4 or pattern\$4)) and ((laser with "1024") (laser with	US-PGPUB;	
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22 12337 (coarse or dense or lonely or isolated) near2 (mask\$4 or resist\$4 or pattern\$4) USPAT; US-PGPUB; EPO; IPO; DERWENT; IBM_TDB USPAT; US-PGPUB; EPO; IPO; DERWENT; US-PGPUB; EPO; IPO; IPO; IPO; IPO; IPO; IPO; IPO; I				DERWENT;	
pattern\$4) 23 128 ((coarse or dense or lonely or isolated) near2 (mask\$4 or resist\$4 or pattern\$4)) with laser 29 100 ((coarse or dense or lonely or isolated) near2 (mask\$4 or resist\$4 or pattern\$4)) with laser 2003/12/01 16:41 2003/12/01 16:41 2003/12/01 16:41 2003/12/01 16:41 2003/12/01 16:41 2003/12/01 16:41 2003/12/01 16:41				IBM TDB	
23 128 ((coarse or dense or lonely or isolated) near2 (mask\$4 or resist\$4 or pattern\$4)) with laser ((coarse or dense or lonely or isolated) near2 (mask\$4 or resist\$4 or pattern\$4)) because of dense or lonely or isolated) near2 (mask\$4 or resist\$4 or pattern\$4) USPAT; USPGPUB; EPO; PO; DERWENT;	22	12337	(coarse or dense or lonely or isolated) near2 (mask\$4 or resist\$4 or		2003/12/01 16:41
23 128 ((coarse or dense or lonely or isolated) near2 (mask\$4 or resist\$4 or EPC; IPO; DERWENT; IBM_TDB USPAT; US-PGPUB; EPO; IPO; DERWENT; US-PGPUB; EPO; IPO; IPO; DERWENT; US-PGPUB; EPO; IPO; IPO; IPO; IPO; IPO; IPO; IPO; I	1		pattern\$4)	US-PGPUB:	
23 DERWENT; DERWENT; IBM_TDB USPAT; US-PGPUB; EPO; IPO; DERWENT; DERWENT; DERWENT; DERWENT; DERWENT; US-PGPUB; DERWENT; DERWEN		(i		EPO; JPO;	
23 ((coarse or dense or lonely or isolated) near2 (mask\$4 or resist\$4 or Pattern\$4)) with laser [BM_TDB_USPAT; US-PGPUB; EPO; PPO; DERWENT; [BM_TDB_USPAT; US-PGPUB; EPO; PPO; EPO; PPO; EPO; PPO; EPO; EPO					
23 128 ((coarse or dense or lonely or isolated) near2 (mask\$4 or resist\$4 or USPĀT; US-PGPUB; PPO; PPO; DERWENT; DERWENT; DERWENT;					
pattern\$4)) with laser US-PGPUB; EPO; JPO; DERWENT;	23	128	((coarse or dense or lonely or isolated) near2 (mask\$4 or resist\$4 or		2003/12/01 16:41
EPO; JPO; DERWENT;					
DERWENT;					i
		1 1			